

10/720,269

FORM PTO 1449 (modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary)		ATTY DOCKET NO. 03650.002191.		APPLICATION NO. N/Y/A			
		APPLICANT YOSHIMASA OKAMURA, ET AL.					
		FILING DATE HERewith		GROUP N/Y/A			
U.S. PATENT DOCUMENTS							
*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
PZ		2002/0158342	10/31/02	Tuominen, et al	428	195	
		2002/0170590	11/21/02	Heremans, et al.	136	240	
		2003/0041892	03/06/03	Parsons, et al.	136	200	
		2003/0047204	03/13/03	Fleurial, et al.	136	200	
		4,971,632	11/20/1990	Rowe	136	212	
		4,983,225	01/08/1991	Rowe	136	201	
		5,286,304	02/15/1994	Macris, et al.	136	201	
		5,581,091	12/03/96	Moskovits et al.	257	9	
		5,837,929	11/17/1998	Adelman	136	225	
		5,921,087	07/13/1999	Bhatia, et al.	62	3.2	
		6,127,619	10/03/2000	Xi, et al.	136	203	
		6,207,887	03/27/2001	Bass, et al.	136	201	
PZ		6,214,738	04/10/2001	Aiba, et al.	438	707	
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT
PZ		63-20880	01/28/1988	JAPAN			Abstract
		11-298051	10/29/1999	JAPAN			Abstract
		2001-282396	10/12/2001	JAPAN			Abstract
PZ		03/077298	09/18/03	PCT			
OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)							
EXAMINER				DATE CONSIDERED			
[Signature]				12/21/04			

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FORM PTO 1449 (modified)				ATTY DOCKET NO. 03650.002195.		APPLICATION NO. N/Y/A	
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				FILING DATE HEREWITH		GROUP N/Y/A	
U.S. PATENT DOCUMENTS							
*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
DN		6,231,744	05/15/2001	Ying, et al.	205	324	
		6,232,542	05/15/2001	Hiraishi, et al.	136	201	
		6,359,288	03/19/2002	Ying, et al.	257	14	
		6,441,295	08/27/2002	Hiraishi, et al.	136	201	
		6,441,296	08/27/2002	Hiraishi, et al.	136	201	
DN		6,605,772	08/12/2003	Harman, et al.	136	236.1	
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT
OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)							
DN		"Introduction to Thermoelectrics", website, http://www.thermoelectrics.com/introduction.htm , site visited July 28, 2003.					
		M.S. Dresselhaus, et al., "The Promise of Low Dimensional Systems for Thermoelectric Applications," website, http://www.osti.gov/fcvtdarpa2002/mdresselhaus.pdf , site visited September 18, 2003.					
		"THERMOELECTRICITY" website, http://www.nanothermel.org/public_main.htm , site visit d July 28, 2003.					
DN		"Stacy Group" Stacy Group Thermoelectrics Research, website, http://www.cchem.berkeley.edu/~amsgrp/thermoelectrics.html , site visited August 29, 2003.					
EXAMINER <i>DN</i>				DATE CONSIDERED 12/21/04			

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		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT
OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)							
		<p>✓ "Design of Advanced Materials" Stacy Group Home, website, http://www.cchem.berkeley.edu/~amsgrp/index.html, site visited July 28, 2003.</p>					
		<p>"Eneco Technology" r-layout2, website, http://www.eneco-usa.com/technology/content.htm, site visited July 28, 2003.</p>					
		<p>Marlow Industries Inc." thermoelectric manufacturer Marlow Industries inc., website, http://www.marlow.com/, site visited July 28, 2003.</p>					
		<p>Hi-Z Technology" Hi-Z TECHNOLOGY, INC., website, http://www.hi-z.com/, site visited July 28, 2003.</p>					
		<p>"TELLUREX Z-Max thermoelectric modules for power generation..." Tellurex Corporation, website, http://www.tellurex.com/, site visited July 28, 2003.</p>					
		<p>"A Quantum Leap in Power Generation" Power Chips plc, website, http://www.powerchips.gi/, site visited July 28, 2003.</p>					
		<p>"The Science Behind Power Chips™, A Basic Introduction" Power Chips plc, website, http://www.powerchips.gi/technology/overview.shtml, site visited July 28, 2003.</p>					
		<p>M.S. Dresselhaus, et al., "INVESTIGATION OF LOW-DIMENSIONAL THERMOELECTRICS", <i>Symposium Proceeding, Technomoic Publishing Co.</i>, pp. 1-13.</p>					
		<p>P2 M.S. Dresselhaus, et al., "NANOWIRES FOR THERMOELECTRIC APPLICATIONS", <i>Massachusetts Institute of Technology</i>.</p>					
EXAMINER				DATE CONSIDERED 12/21/04			

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